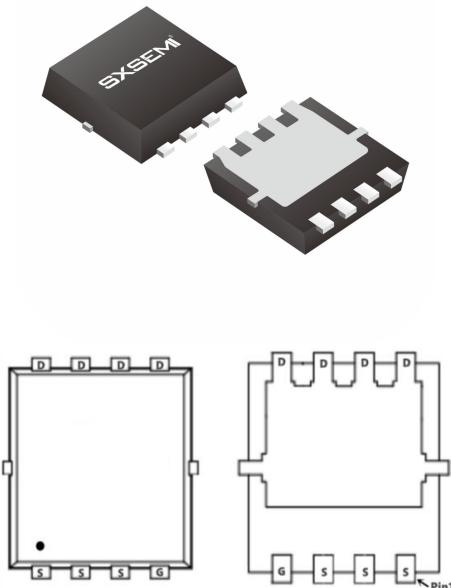


General Description

SXG110N06NF use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable to use in

PDFN5*6-8L

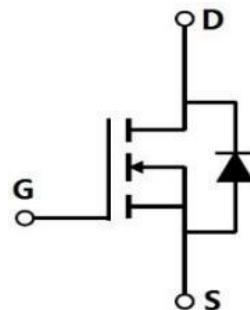


Features

- Low RDS(on) & FOM
- Extremely low switching loss
- Excellent stability and uniformity or Invertors

Applications

- Consumer electronic power supply
- Motor control
- Synchronous-rectification
- Isolated DC
- Synchronous-rectification applications



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	60	V
VGS	Gate-Source Voltage	± 20	V
$I_D @ T_c = 25^\circ\text{C}$	Continuous Drain Current ^{1,6}	110	A
$I_D @ T_c = 100^\circ\text{C}$	Continuous Drain Current ^{1,6}	66	A
IDM	Pulsed Drain Current ²	240	A
EAS	Single Pulse Avalanche Energy ³	101	mJ
IAS	Avalanche Current	45	A
$P_D @ T_c = 25^\circ\text{C}$	Total Power Dissipation ⁴	83	W
TSTG	Storage Temperature Range	-55 to 150	°C
T_j	Operating Junction Temperature Range	-55 to 150	°C
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹	55	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	1.5	°C/W

Electrical Characteristics (T_c=25 °C unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250μA	60	---	---	V
R _{DSON}	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =20A	---	3.0	3.6	mΩ
		V _{GS} =4.5V , I _D =15A	---	4.4	5.4	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250μA	1.2	---	2.3	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =48V , V _{GS} =0V , T _J =25 °C	---	---	1	uA
		V _{DS} =48V , V _{GS} =0V , T _J =55 °C	---	---	5	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V	---	---	±100	nA
g _{fs}	Forward Transconductance	V _{DS} =5V , I _D =20A	---	65	---	S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	---	0.7	---	Ω
Q _g	Total Gate Charge (10V)	V _{DS} =30V , V _{GS} =10V , I _D =20A	---	58	---	nC
Q _{gs}	Gate-Source Charge		---	16	---	
Q _{gd}	Gate-Drain Charge		---	4	---	
T _{d(on)}	Turn-On Delay Time	V _{DD} =30V , V _{GS} =10V , R _G =3 , I _D =20A	---	18	---	ns
T _r	Rise Time		---	8	---	
T _{d(off)}	Turn-Off Delay Time		---	50	---	
T _f	Fall Time		---	10.5	---	
C _{iss}	Input Capacitance	V _{DS} =30V , V _{GS} =0V , f=1MHz	---	3458	---	pF
C _{oss}	Output Capacitance		---	1522	---	
C _{rss}	Reverse Transfer Capacitance		---	22	---	
I _S	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	---	---	55	A
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25 °C	---	---	1.2	V
t _{rr}	Reverse Recovery Time	I _F =20A , dI/dt=100A/μs , T _J =25 °C	---	24	---	nS
Q _{rr}	Reverse Recovery Charge		---	85	---	nC

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The EAS data shows Max. rating . The test condition is V_{DD}=50V,V_{GS}=10V,L=0.1mH,I_{AS}=40A
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.
- 6.The maximum current rating is package limited.

Typical Characteristics

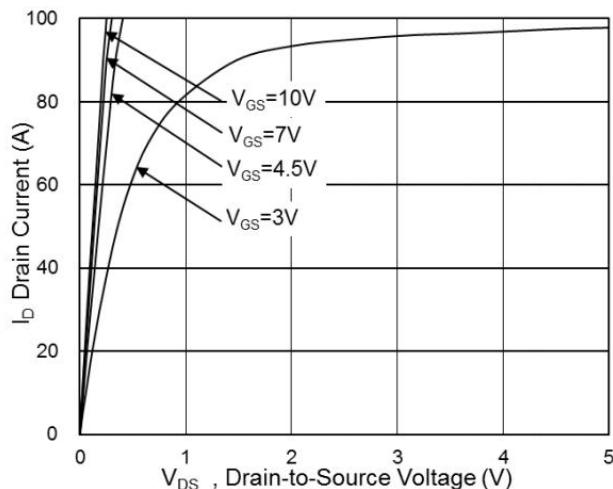


Fig.1 Typical Output Characteristics

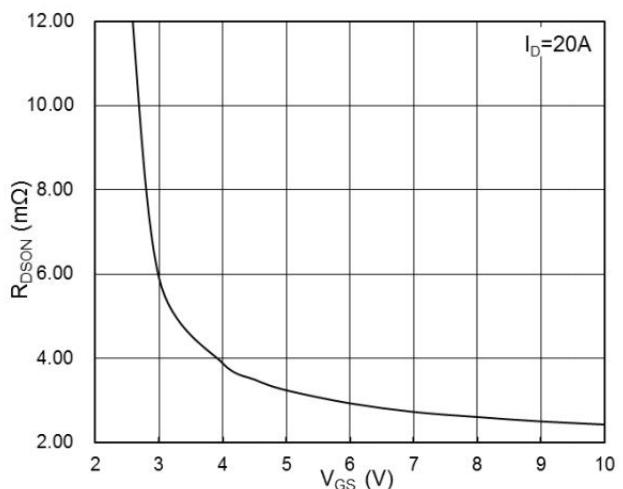


Fig.2 On-Resistance vs G-S Voltage

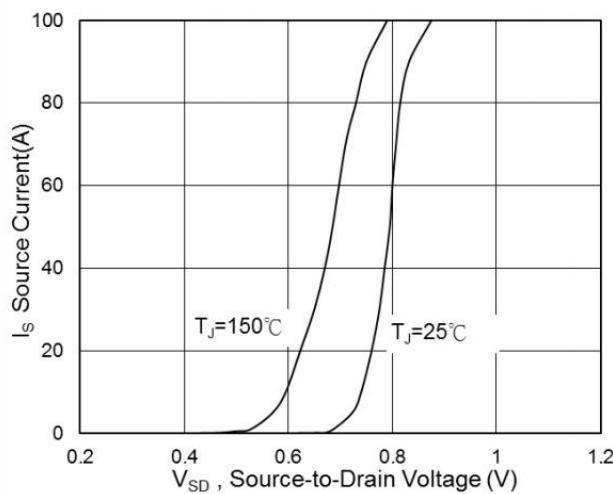


Fig.3 Diode Forward Voltage vs. Current

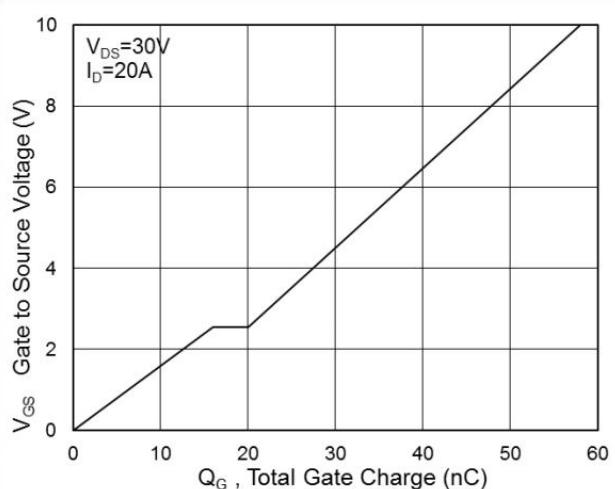


Fig.4 Gate-Charge Characteristics

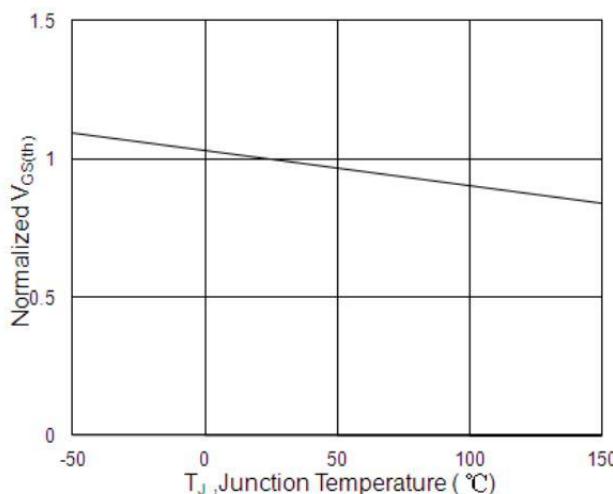


Fig.5 Normalized $V_{GS(th)}$ vs T_J

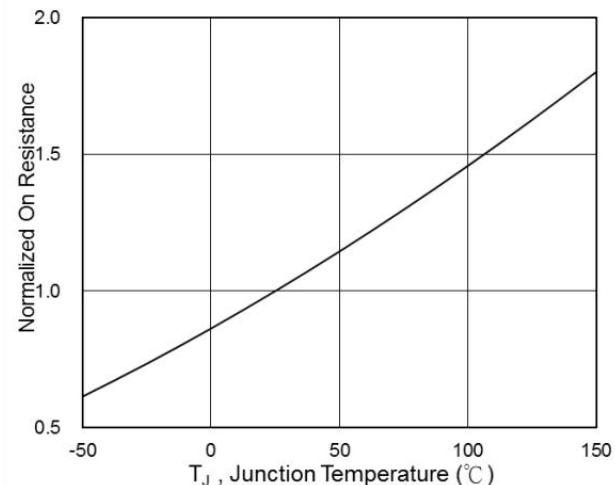


Fig.6 Normalized $R_{DS(on)}$ vs T_J

Typical Characteristics

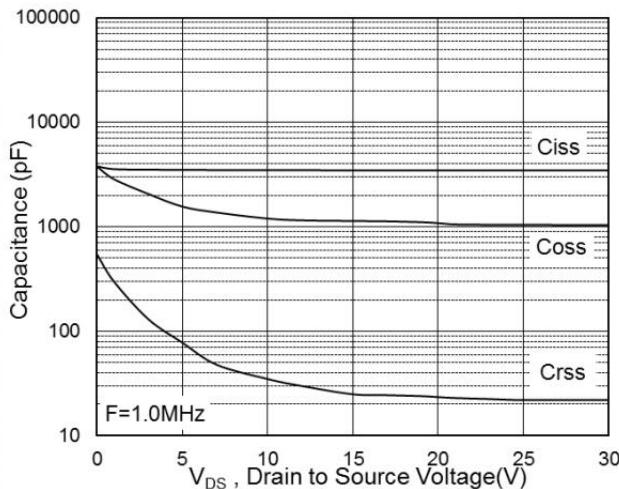


Fig.7 Capacitance

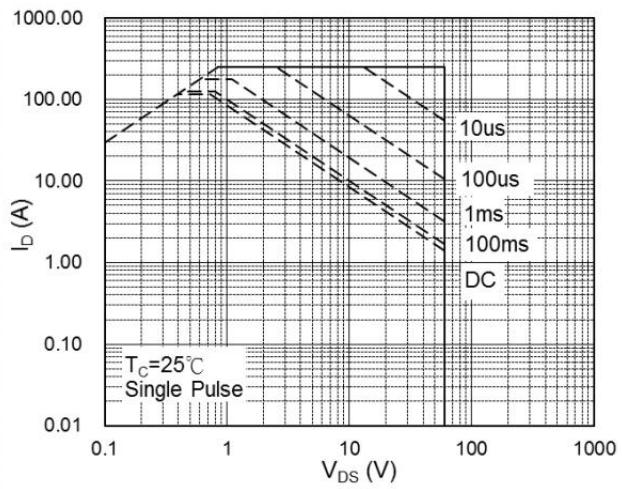


Fig.8 Safe Operating Area

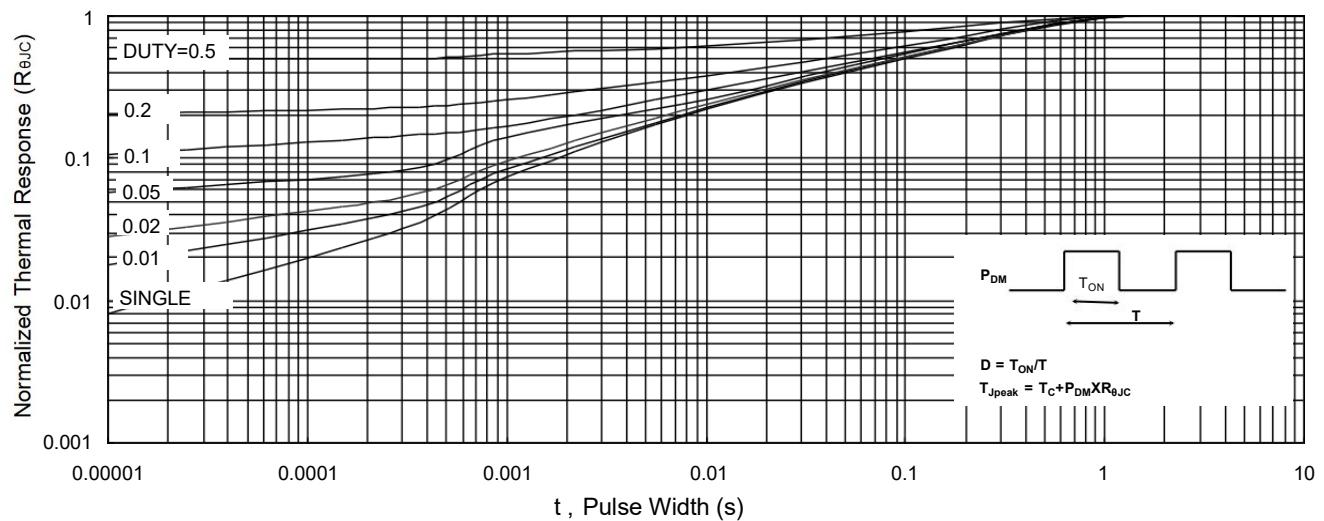


Fig.9 Normalized Maximum Transient Thermal Impedance

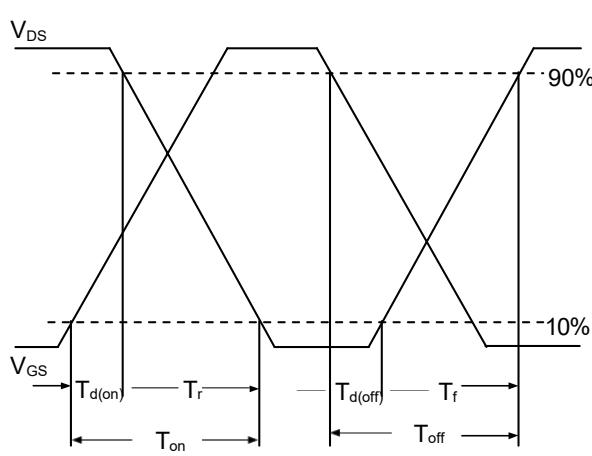


Fig.10 Switching Time Waveform

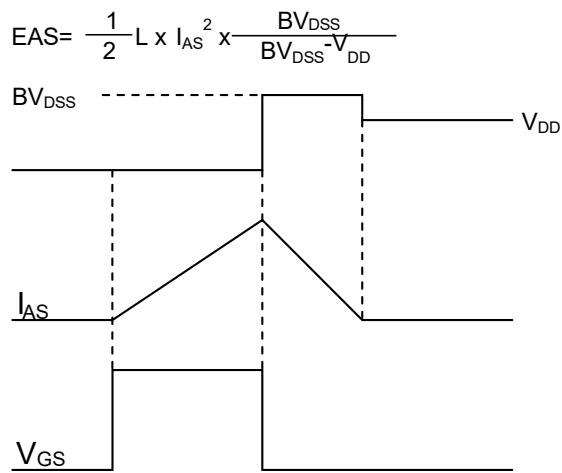
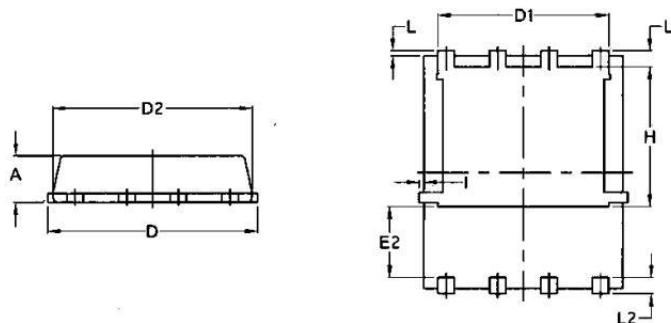
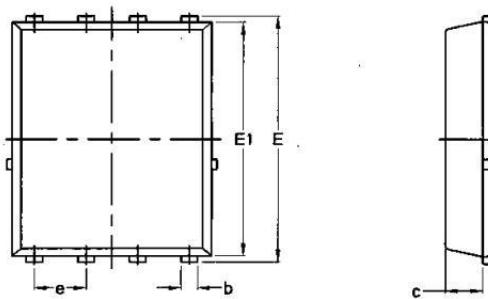


Fig.11 Unclamped Inductive Switching Waveform

MOSFET Package Mechanical Data-PDFN5*6-8L-JQ Single

Symbol	Common			
	mm		Inch	
	Mim	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
TAPING	PDFN5*6-8L		5000